## $3.9 \times 2.9 \mathrm{~mm}$ Compact Type (Surface Mount) SKRK Series

| Type | Surface mount |
| :---: | :---: |
| Operating force | 0.98N |
| Operating direction | Top push |
| Travel | 0.13 mm |
| Operating life (5mA 5V DC) | 200,000 cycles |
| Initial contact resistance | $500 \mathrm{~m} \Omega$ max. |
| Stem height | 2 mm |
| Series type | Sharp feeling type |
| Operating temperature range | $-30^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Rating (max.) | 50mA 12V DC |
| Rating (min.) | 10ヶA 1V DC |
| Electrical Insulation resistance $100 \mathrm{M} \Omega \mathrm{min}$. 100 V DC for 1 min . |  |
| Voltage proof | 250V AC for 1 min. |
| Durability Vibration | 10 to 55 to $10 \mathrm{~Hz} / \mathrm{min}$., the amplitude is 1.5 mm for all the frequencies, in the 3 direction of $X, Y$ and $Z$ for 2 hours respectively |
| Environmental performance | $-30 \pm 2^{\circ} \mathrm{C}$ for 96 h |
|  | $80 \pm 2^{\circ} \mathrm{C}$ for 96 h |
|  | $60 \pm 2^{\circ} \mathrm{C}, 90$ to $95 \% \mathrm{RH}$ for 96 h |
| Minimum order unit (pcs.) | 4,500 |
|  | 4,500 |

## Dimensions



Land Dimensions


Viewed from mounting face.

## Circuit Diagram



## Packing Specifications

## Taping



| Number of packages (pcs.) | 1 reel | 4,500 |
| :---: | :---: | :---: |
|  | 1 case / Japan | 45,000 |
|  | 1 case / export packing | 45,000 |
| Tape width (mm) |  | 12 |
| Export package meas | surements (mm) | $395 \times 395 \times 205$ |

## Soldering Conditions

## Condition for Reflow

1. Heating method

Double heating method with infrared heater.
2. Temperature measurement

Thermocouple 0.1 to $0.2 \Phi \operatorname{CA}(\mathrm{~K})$ or $\mathrm{CC}(\mathrm{T})$ at solder joints (copper foil surface). A heat resisting tape should be used for fix measurement.
3. Temperature profile

Temperature ( ${ }^{\circ} \mathrm{C}$ )

(1) The above temperature shall be measured of the top of switch. There are cases where PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC board's and others. Care, should be taken to prevent the switch's surface temperature from exceeding $260^{\circ} \mathrm{C}$.
(2) Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Manual Soldering

| Items | Condition |
| :--- | :--- |
| Soldering temperature | $350^{\circ} \mathrm{C}$ max. |
| Duration of soldering | 3 s max. |
| Capacity of soldering iron | $60 W$ max. |

1. Consult with us for availability of TACT switch ${ }^{\text {TM }}$ washing.
2. Prevent flux penetration from the top side of the TACT switch ${ }^{T M}$.
3. Switch terminals and a PC board should not be coated with flux prior to soldering.
4. The second soldering should be done after the switch returns to normal temperature.

## Notes are common to this series/models.

1. This site catalog shows only outline specifications. When using the products, please obtain formal specifications for supply.
2. Please place purchase orders for taping products per minimum order unit (1 reel or a case).
3. For $\varphi 330 \mathrm{~mm}$ diameter reel requirements, please contact us.
4. Please contact us for automotive use products.

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